

SOT89 NPN SILICON POWER (SWITCHING) TRANSISTOR

FCX619

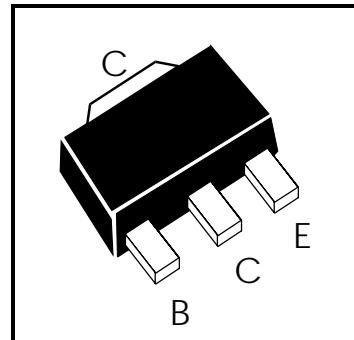
ISSUE 6 - JANUARY 2003

FEATURES

- * 2W POWER DISSIPATION
- * 6A PEAK PULSE CURRENT
- * EXCELLENT h_{FE} CHARACTERISTICS UP TO 6 Amps
- * EXTREMELY LOW SATURATION VOLTAGE e.g. 13mV typ.
- * EXTREMELY LOW EQUIVALENT ON-RESISTANCE;
- * $R_{CE(sat)}$ 87m Ω at 2.75A

COMPLIMENTARY TYPE - FCX720

PARTMARKING DETAIL - 619



ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	VALUE	UNIT
Collector-Base Voltage	V_{CBO}	50	V
Collector-Emitter Voltage	V_{CEO}	50	V
Emitter-Base Voltage	V_{EBO}	5	V
Peak Pulse Current	I_{CM}	6	A
Continuous Collector Current †	I_C	3.0	A
Base Current	I_B	500	mA
Power Dissipation at $T_{amb}=25^\circ\text{C}$	P_{tot}	1.5† 2‡	W
Operating and Storage Temperature Range	$T_j; T_{stg}$	-55 to +150	°C

† recommended P_{tot} calculated using FR4 measuring 25x25x0.6mm

‡ Maximum power dissipation is calculated assuming that the device is mounted on FR4 substrate measuring 40x40x0.6mm and using comparable measurement methods adopted by other suppliers.

**Measured under pulsed conditions. Pulse width=300 μs . Duty cycle $\leq 2\%$

Spice parameter data is available upon request for these devices

Refer to the handling instructions for soldering surface mount components.

FCX619

ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^\circ C$ unless otherwise stated).

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	50	190		V	$I_C=100\mu A$
Collector-Emitter Breakdown Voltage	$V_{(BR)CEO}$	50	65		V	$I_C=10mA^*$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	5	8.3		V	$I_E=100\mu A$
Collector Cut-Off Current	I_{CBO}			100	nA	$V_{CB}=40V$
Emitter Cut-Off Current	I_{EBO}			100	nA	$V_{EB}=4V$
Collector Emitter Cut-Off Current	I_{CES}			100	nA	$V_{CES}=40V$
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$		13 150 190 240	25 220 260 320	mV mV mV mV	$I_C=0.1A, I_B=10mA^*$ $I_C=1A, I_B=10mA^*$ $I_C=2A, I_B=50mA^*$ $I_C=2.75A, I_B=100mA^*$
Base-Emitter Saturation Voltage	$V_{BE(SAT)}$		0.97	1.1	V	$I_C=2.75A,$ $I_B=100mA^*$
Base-Emitter Turn-On Voltage	$V_{BE(ON)}$		0.89	1.0	V	$I_C=2.75A, V_{CE}=2V^*$
Static Forward Current Transfer Ratio	h_{FE}	200 300 200 100	400 450 400 200 30			$I_C=10mA, V_{CE}=2V^*$ $I_C=200mA, V_{CE}=2V^*$ $I_C=1A, V_{CE}=2V^*$ $I_C=2A, V_{CE}=2V^*$ $I_C=6A, V_{CE}=2V^*$
Transition Frequency	f_T	100	165		MHz	$I_C=50mA, V_{CE}=10V$ $f=100MHz$
Output Capacitance	C_{OBO}		12	20	pF	$V_{CB}=10V, f=1MHz$
Turn-On Time	$t_{(ON)}$		170		ns	$V_{CC}=10V, I_C=1A$
Turn-Off Time	$t_{(OFF)}$		750		ns	$I_{B1}=-I_{B2}=10mA$

*Measured under pulsed conditions. Pulse width=300μs. Duty cycle ≤ 2%

Spice parameter data is available upon request for this device



FCX619

TYPICAL CHARACTERISTICS

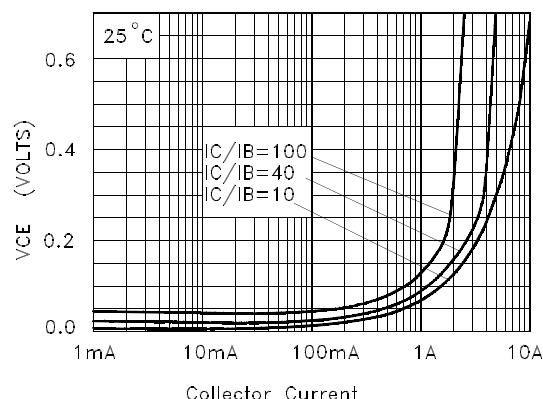


FIG. 1 $V_{CE(SAT)}$ vs I_C

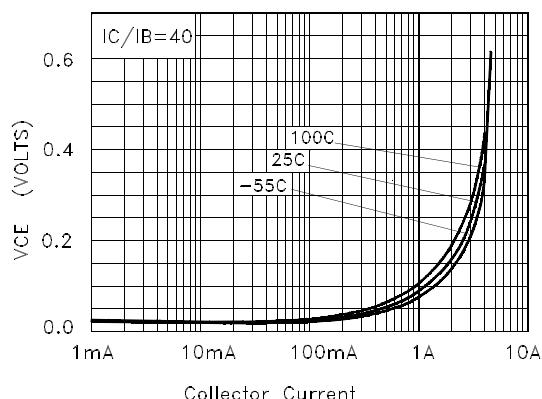


FIG. 2 $V_{CE(SAT)}$ vs I_C

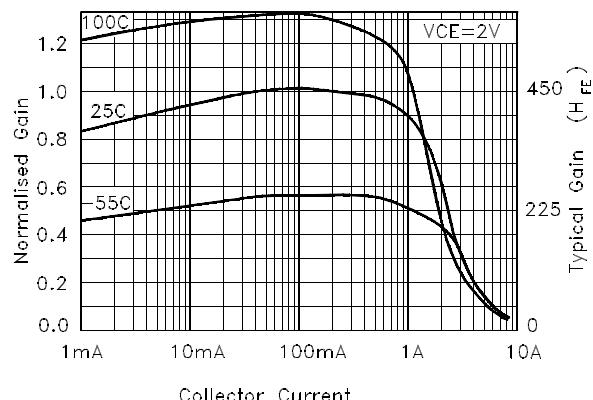


FIG. 3 H_{FE} vs I_C

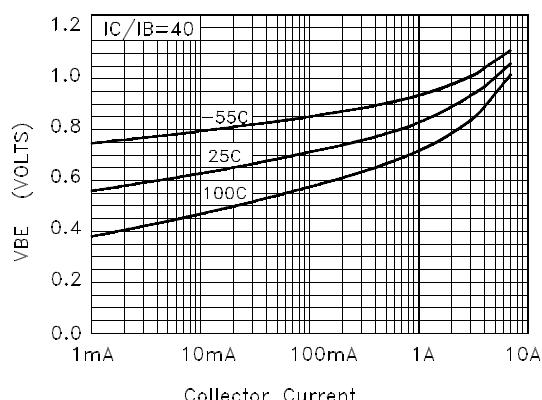


FIG. 4 $V_{BE(SAT)}$ vs I_C

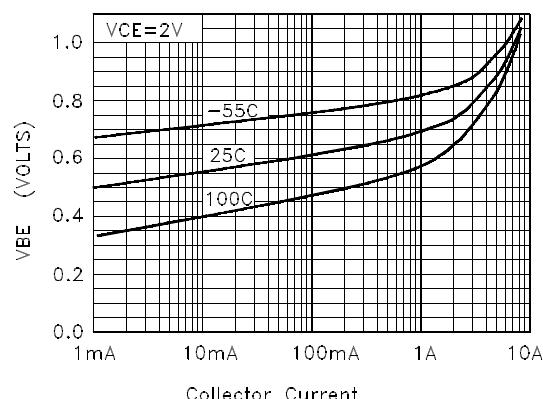


FIG. 5 $V_{BE(ON)}$ vs I_C